

## SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER

Reverse Voltage - 50 to 1000 V

Forward Current - 1 A

## FEATURES

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- High efficiency
- Lead free in comply with EU RoHS 2011/65/EU directives

## MECHANICAL DATA

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg / 0.00095oz

## PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View

Marking Code: US1A~US1M

Simplified outline SMAF and symbol

## Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

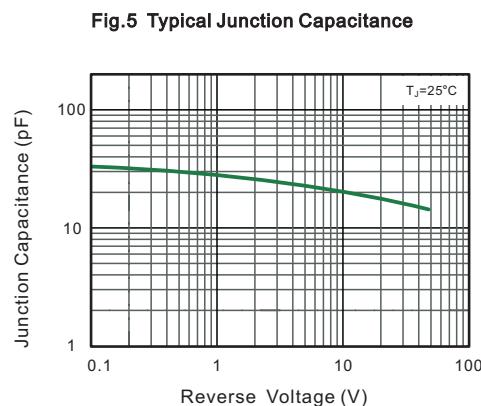
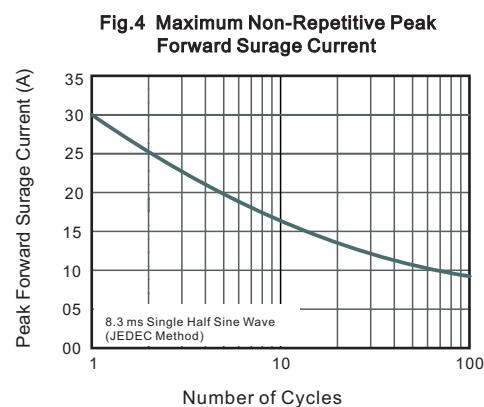
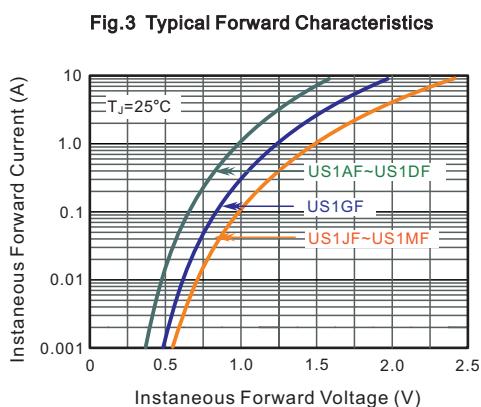
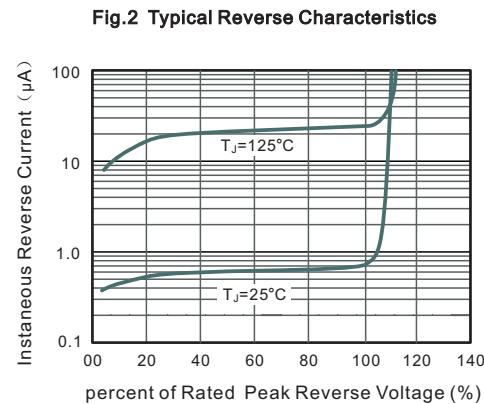
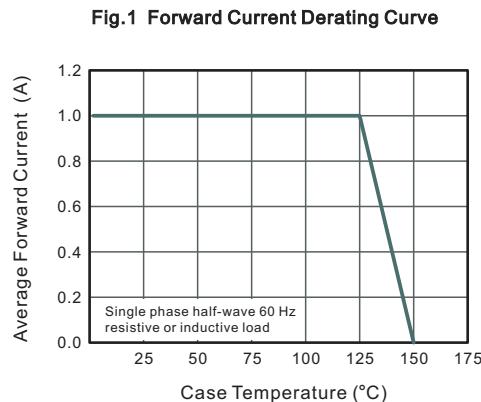
Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	US1AF	US1BF	US1DF	US1GF	US1JF	US1KF	US1MF	Units					
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V					
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V					
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V					
Maximum Average Forward Rectified Current at T <sub>c</sub> = 125 °C	I <sub>F(AV)</sub>	1							A					
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I <sub>FSM</sub>	30							A					
Maximum Instantaneous Forward Voltage at 1 A	V <sub>F</sub>	1.0		1.3		1.65		V						
Maximum DC Reverse Current    T <sub>a</sub> = 25 °C at Rated DC Blocking Voltage    T <sub>a</sub> = 125 °C	I <sub>R</sub>	5 100							µA					
Maximum Reverse Recovery Time <sup>(1)</sup>	t <sub>rr</sub>	50			75			ns						
Typical Junction Capacitance <sup>(2)</sup>	C <sub>j</sub>	15							pF					
Typical Thermal Resistance <sup>(3)</sup>	R <sub>θJA</sub>	80							°C/W					
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 ~ +150							°C					

(1) Measured with I<sub>F</sub> = 0.5 A, I<sub>R</sub> = 1 A, I<sub>rr</sub> = 0.25 A.

(2) Measured at 1 MHz and applied reverse voltage of 4 V D.C

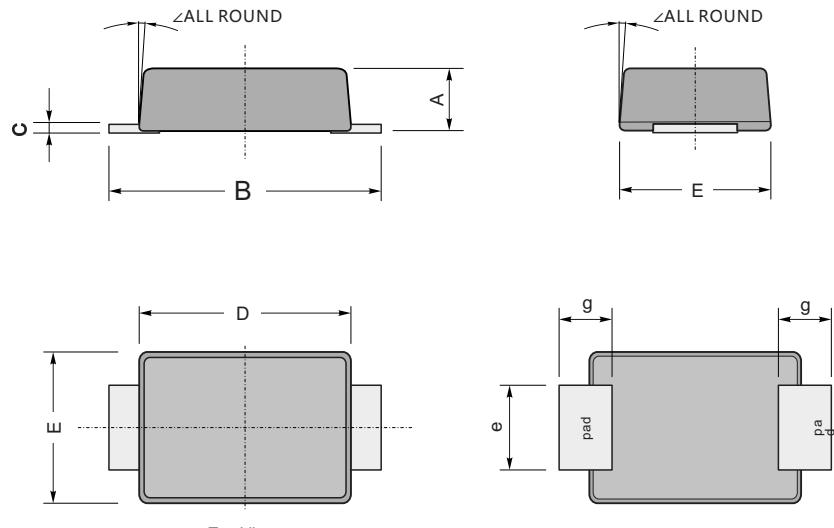
(3) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



## PACKAGE OUTLINE

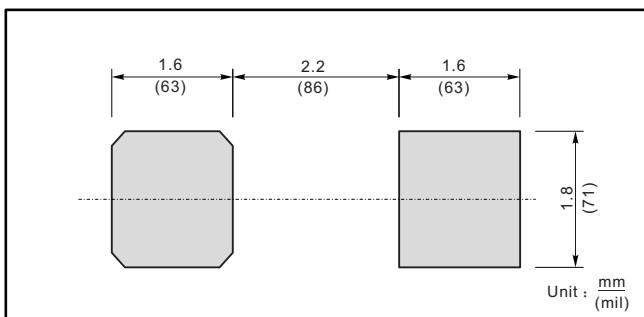
Plastic surface mounted package; 2 leads

**SMAF**



UNIT		A	C	D	E	e	g	B	∠
mm	max	1.2	0.20	3.7	2.7	1.6	1.2	4.9	$5^\circ$
	min	0.9	0.12	3.3	2.4	1.3	0.8	4.4	
mil	max	47	7.9	146	106	63	47	193	$5^\circ$
	min	35	4.7	130	94	51	31	173	

### The recommended mounting pad size



### Marking

Type number	Marking code
US1AF	US1A
US1BF	US1B
US1DF	US1D
US1GF	US1G
US1JF	US1J
US1KF	US1K
US1MF	US1M